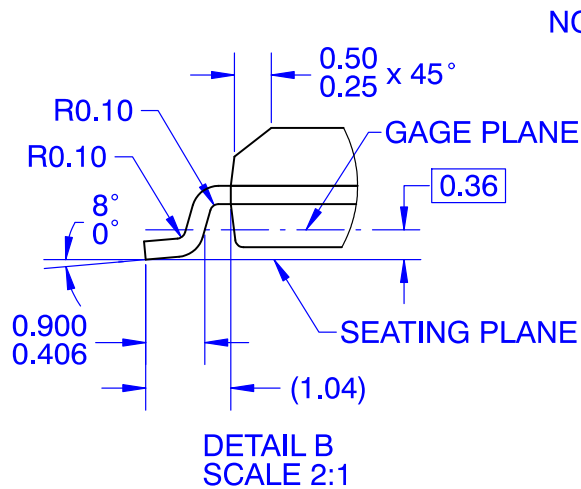
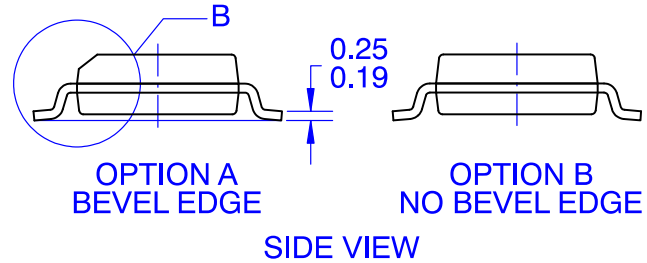
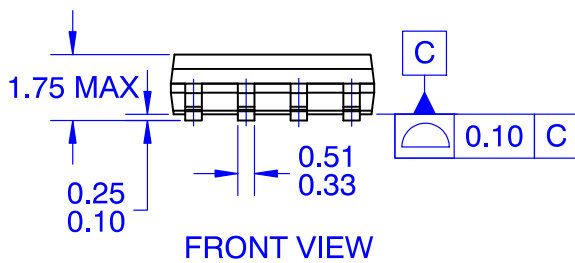
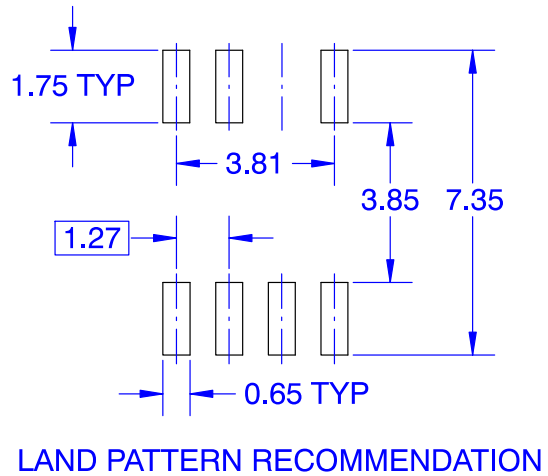
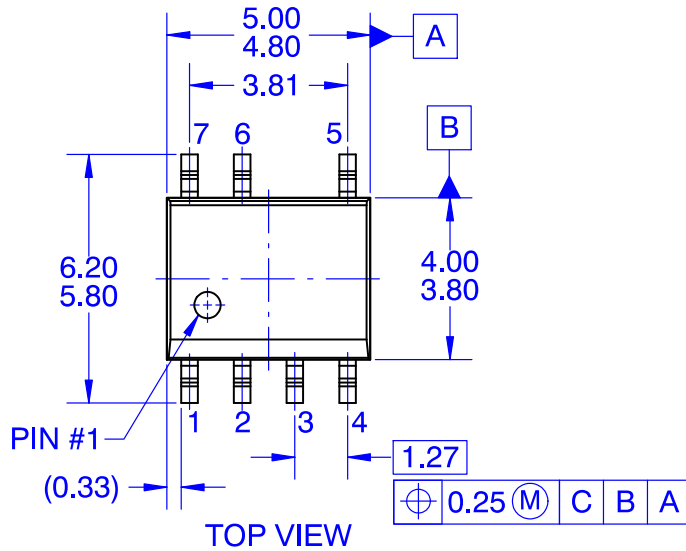


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CASE 751ED
ISSUE O

DATE 30 SEP 2016



NOTES:

- A. THIS PACKAGE DOES NOT FULLY CONFORM TO JEDEC MS-012, VARIATION AA
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS

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|-------------------------|--------------------|---|
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